03/14/2017 504271612

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4318294

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KANGHO LEE	02/17/2015
JIMMY KAN	01/08/2015
XIAOCHUN ZHU	01/08/2015
MATTHIAS GEORG GOTTWALD	01/12/2015
CHANDO PARK	01/08/2015
SEUNG HYUK KANG	01/08/2015

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15458641

CORRESPONDENCE DATA

Fax Number: (310)201-5219

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (310) 201-5262

Email: qualcomm-uspto@seyfarth.com

QUALCOMM INCORPORATED/SEYFARTH SHAW LLP **Correspondent Name:**

Address Line 1: 2029 CENTURY PARK EAST, SUITE 3500

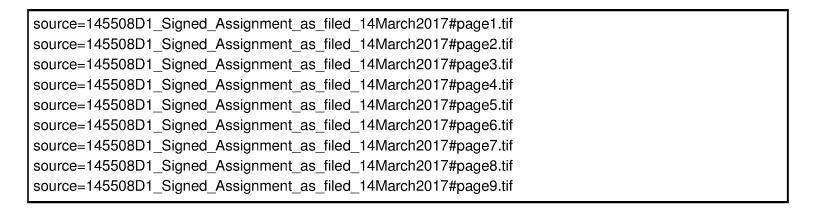
Address Line 4: LOS ANGELES, CALIFORNIA 90067

ATTORNEY DOCKET NUMBER:	145508D1
NAME OF SUBMITTER:	JOSEPH LUTZ
SIGNATURE:	/Joseph Lutz/
DATE SIGNED:	03/14/2017

Total Attachments: 9

PATENT REEL: 041573 FRAME: 0102

504271612



ASSIGNMENT

WHEREAS, WE.

- Kangho LEE, a citizen of Korea, having a mailing address located at 11515 Caminito La Bar #82, San Diego, CA 92126, U.S.A., and a resident of San Diego, California,
- Jimmy KAN, a citizen of Canada, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of San Diego, California.
- Xiaochun ZHU, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of San Diego, California,
- Matthias Georg GOTTWALD, a citizen of Germany, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of Leuven, Belgium
- Chande PARK, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of San Diego, California.
- Seung Hyuk KANG, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of San Diego, California.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to ULTRATHIN PERPENDICULAR PINNED LAYER STRUCTURE FOR MAGNETIC TUNNELING JUNCTION DEVICES (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States,

including but not limited to U.S. Application No(s). 14/581,361 filed December 23, 2014, Qualcomm Reference No. 145508, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	SAN DIEGO, on LOCATION CA	2-17-15	Janle
	LOCATION CA-	DATE	Kangho LEE
Done at _	, on,	DATE	Jimmy KAN
Done at_	LOCATION on	DATE	Xiaochun ZHU
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	LOCATION	DATE	Matthias Georg GOTTWALD
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	LOCATION on	DATE	Chando PARK
Done at	.on		
rom at	LOCATION	DATE	Seung Hyuk KANG

ASSIGNMENT

WHEREAS, WE,

- 1. Kangho LEE, a citizen of Korea, having a mailing address located at 11515 Caminito La Bar. #82, San Diego, CA 92126, U.S.A., and a resident of San Diego, California,
- Jimmy KAN, a citizen of Canada, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of San Diego, California.
- Xiaochun ZHU, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714. U.S.A., and a resident of San Diego, California.
- Matthias Georg GOTTWALD, a citizen of Germany, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of Leuven, Belgium
- Chando PARK, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., and a resident of San Diego, California.
- Seung Hyuk KANG, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714. U.S.A., and a resident of San Diego. California.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to ULTRATHIN PERPENDICULAR PINNED LAYER STRUCTURE FOR MAGNETIC TUNNELING JUNCTION DEVICES (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States.

including but not limited to U.S. Application No(s). 14/581,361 filed December 23, 2014, Qualcomm Reference No. 145508, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof:

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref. No. 145508 Paga 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

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Done at		<u> </u>	
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same as	LOCATION	DATE	Xiaochun ZHU
Done at	, on		
	LOCATION	DATE	Matthias Georg GOTTWALD
	A Company	717.6716	17722(6.5
Done at	CONTINUE CON	DATE	Chando PARK
Managari	San 1200 0, on	16/20/	
twine at	LOCATION 'V"	DATE	Seung Hyuk KANG

ASSIGNMENT

WHEREAS, WE.

- Kangho LEE, a citizen of Korea, having a mailing address located at 11515 Caminito La Bar #82, San Diego, CA 92126, U.S.A., and a resident of San Diego, California.
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WHEREAS. QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States.

including but not limited to U.S. Application No(s). 14/581,361 filed December 23, 2014, Qualcomm Reference No. 145508, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

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AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

PATENT

QUALCOMM Ref. No. 145508

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

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	LOCATION , on	DATE	Kangbo LEE
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voncar_	, on LOCATION	DATE	Jimmy KAN
one at _	, on		#25. \$ 990 F.W. 2
	LOCATION	DATE	Xiaochun ZHU
kone at	/ <i>PUVEA/</i> .m	O1/12/15	MARAL
one at	LEUVEN/, on_	<u>01/12/15</u> date	Matthias Georg GOTTWALD
one at	LEUVEA/_, on LOCATION	O( / (2 / ) (5	Matthias Georg GOTTWALD
one at	(E//VEN/, on_ LOCATION	<u>Ø/ //2 / /5</u> DATE	Matthias Georg GOTTWALD
one at	LOCATION, on	<u>01/12/15</u> DATE	
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PATENT REEL: 041573 FRAME: 0112

RECORDED: 03/14/2017